

1723

<b>AMENDMENT TRANSMITTAL LETTER (Large Entity)</b>				Docket No. 2802-257-006	
Applicant(s): Michael Bunyan, et al					

Application No. 09/714,680	Filing Date 11/16/2000	Examiner D. L. Tarazano	Customer No. 23984	Group Art Unit 1773	Confirmation No. 4369
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CONFORMAL THERMAL INTERFACE MATERIAL FOR ELECTRONIC COMPONENTS

COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.  
The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE		ADDITIONAL FEE
TOTAL CLAIMS	11 -	20 =	0	x	\$50.00	\$0.00
INDEP. CLAIMS	2 -	3 =	0	x	\$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>						\$0.00
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>						<b>\$0.00</b>

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. 16-0325 in the amount of
- ☐ A check in the amount of to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account
  - ☒ Any additional filing fees required under 37 C.F.R. 1.16.
  - ☐ Any patent application processing fees under 37 CFR 1.17.
- ☐ Payment by credit card. Form PTO-2038.

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Signature

Dated: October 4, 2005

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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on	
October 4, 2005 (Date)	
 Signature of Person Mailing Correspondence	
<b>JOHN A. MOLNAR, JR.</b>	
Typed or Printed Name of Person Mailing Correspondence	

cc:

Appl. No. Serial No. 09/714,680  
Amdt. dated October 4, 2005  
Reply to Office action of September 30, 2005



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. for Reissue No. : 09/714,680  
Patent No. : 6,054,198  
Applicant : Bunyan *et al.*  
Filed : November 16, 2000  
Title : Conformal Thermal Interface  
Material For Electronic Components

TC/A.U. : 1773  
Examiner : D. L. Tarazano

Docket No. : 2802-257-006

Honorable Commissioner For Patents  
Alexandria, VA 22313-1450

**RESPONSE**

In response to the Notice of Non-Compliant Amendment mailed September 30, 2005, the corrected section of the non-compliant Amendment is resubmitted herewith in its entirety.

**Amendments to the Claims** are reflected in the listing of the claims which begins on page 2 of this paper.

**Remarks** begin on page 5 of this paper.